



How To Order

RI - (1) (2) / (3) - (4) / (5)

(1) No. of contact (2) P : Plug S : Socket

(3) 1 : Single Row / 2 : Double Row / 3 : 0.3" Row to Row Pitch / 4 : 0.4" Row to Row Pitch / 6 : 0.6" Row to Row Pitch

(4) Contact Plating

GF : Gold Flash/T200 : Tin 200 μ"/SG : Select Gold Flash/

S10 : Select Gold plated 10 μ"/S15 : Select Gold plated

15 μ"/S30 : Select Gold plated 30 μ"

(5) Blanked : Dip Solder Type/W : Wire Wrapping/D : SMD Type

E : Empty, No Bar

Ex. RI - 08S/1 - SG

Round IC Socket 8Pin, Socket/ **Single** Row, Select Gold Flash

Ex. RI - 12S/1 - SG

Round IC Socket 12Pin, Socket/ **Single** Row, Select Gold Flash

Technical Data

Material:

Pin(outer sleeve): Brass, machined CuZn38Pb2

Plating(outer sleeve):

Tin plated: 2μm/80u" Ni, 5μm/200u" Sn

Gold Plated: 2μm/80u" Ni, Full gold

Insulator(black): PPS UL94V-0 Glass filled

Electrical:

Current rating: 3Amps/contact max.

Contact resistance: ≤ 4mΩ/contact

Insulation resistance: ≥ 1000MΩ at V=100V

Operating voltage: 60VAC/DC

Mechanical:

Operating temperatures: Gold Plated: -55°C to +125°C

Tin plated: -40°C to +105°C

Soldering temperature: +260°C, 10s max.

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		TOLERANCES ARE		APPROVED	DATE	DRAWING NO		
		X. ±0.25						
		X.X ±0.1		CHECKED	DATE	NAME		
		X.XX ±0.01						
		X.XXX ±0.005						
		X.XXXX ±0.002						
△	新圖發行	Lee	2006-06-02	DRAWN	DATE	UNIT	SCALE	REV
SER	REVISIONS	CHK	DATE	Lee	2006/06/02	MM	1:1	A